SCOPE:

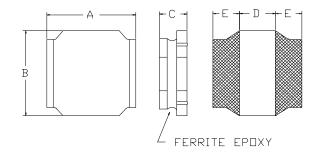
This specification applies to the Pb Free high current type SMD inductors for MNR-3010-SERIES

PRODUCT INDENTIFICATION

MNR - 3010 - 2R2 M

- 1
- 2
- 3 4
- ① Product Code
- ② Dimensions Code
- **3 Inductance Code**
- **4** Tolerance Code

(1) SHAPES AND DIMENSIONS



A: 3.0±0.1 mm

B: 3.0±0.1 mm

C: 1.0±0.1 mm

D: 1.2Typ. mm

E: 0.9Typ. mm

(2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

TEST INSTRUMENTS

L : HP 4284A PRECISION LCR METER (or equivalent)

SRF: HP 4291B IMPEDANCE ANALYZER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

(3) CHARACTERISTICS

(3)-1 Ambient temperature +60°C Max.

(3)-2 Operate temperature range $-40\% \sim +125\%$

(Including self temp. rise)

(3)-3 Storage temperature range -40% \sim +125%

TABLE 1

MAGLAYERS	Inductance	Percent	L Test	SRF(MHz)	Resistance	Rated DC Current	
PT/NO.	L(µH)	Tolerance	Frequency	Min.	RDC(Ω)±20%	IDC1(A)	IDC2(A)
MNR-3010-1R0□	1.0	N	100kHz/0.25V	126	65m	1.30	1.40
MNR-3010-1R5	1.5	N	100kHz/0.25V	98	80m	1.20	1.30
MNR-3010-2R2	2.2	M,N	100kHz/0.25V	82	95m	1.10	1.10
MNR-3010-3R3	3.3	M,N	100kHz/0.25V	63	0.14	0.87	0.94
MNR-3010-4R7	4.7	M,N	100kHz/0.25V	56	0.19	0.75	0.78
MNR-3010-6R8	6.8	M,N	100kHz/0.25V	46	0.30	0.61	0.63
MNR-3010-220	22	M,N	100kHz/0.25V	25	1.03	0.35	0.35

 \divideontimes \square specify the inductance tolerance , M(±20%) , N(±30%)

% IDC1 : Based on inductance change (\triangle L/Lo : drop 30% Max.) @ ambient temp. 25 $^{\circ}$ C

IDC2 : Based on temperature rise ($\triangle T$: 40°C Typ.) Rated DC Current : The less value whith is IDC1 or IDC2.



(4) RELIABILITY TEST METHOD MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS			
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board			
		in figure 1 and a load applied unitil the figure in the arrow			
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)			
	no mechanical	PCB dimension shall the page 7/9			
	damage or elec-	F(Pressurization)			
	trical damege.	л			
		R5 45±2 45±2 10 20 10 R340			
		PRESSURE ROD figure-1			
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board			
		and when a vibration having an amplitude of 1.52mm			
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should			
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.			
	damage.	(A total of 6 hours)			
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated			
Solderability	More than 90%	over the whole of the sample before hard, the sample shall			
		then be preheated for about 2 minutes in a temperature of			
		130~150℃ and after it has been immersed to a depth 0.5mm			
		below for 3±0.2 seconds fully in molten solder M705 with			
		a temperature of 245±5℃.			
		More than 90% of the electrode sections shall be couered			
		with new solder smoothly when the sample is taken out of			
		the solder bath.			

MECHANICAL

TEST ITEM	SPECIFICATION					
TEST ITEM Resistance to There shall be no damage or problems.		SPECIFICATION Temperature profile of reflow soldering soldering (Reak temperature 260±3°C 10 sec 150 Pre-heating Slow cooling (Stored at room temperature) 2 min 10 sec. 2 min or mare				
		The specimen shall be passed through the reflow oven with the condition shown in the above profile for 1 time. The specimen shall be stored at standard atmospheric conditions for 1 hour, after which the measurement shall be made.				

ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS		
Insulation	There shall be	DC 100V voltage shall be applied across this sample of top		
resistance	no other	surface and the terminal.		
	damage or	The insulation resistance shall be more than $1 \times 10^8 \Omega$.		
	problems.			
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top		
withstand	no other	surface and the terminal of this sample		
voltage	damage or			
	problems.			
Temperature	∆L/L20°C ≦±10%	The test shall be performed after the sample has stabilized in		
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85 $^{\circ}\!$		
		calculated based on the value applicable in a normal		
		temperature and narmal humidity shall be △L/L20°C ≦±10%.		



ENVIROMENT CHARACTERISTICS

TEST ITEM				SPECIFICATION				
High temperature	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in an atmospere with						
storage		a tempe	a temperature of 85±2℃ and a normal humidity.					
	There shall be	Upon co	Upon completion of the measurement shall be made after the					
	no mechanical	sample I	sample has been left in a normal temperature and normal					
	damage.	humidity	humidity for 1 hour.					
Low temperature	∆L/Lo≦±5%	The sam	The sample shall be left for 96±4 hours in an atmosphere with					
storage		a tempe	a temperature of -25 ±3 °C .					
	There shall be	Upon co	Upon completion of the test, the measurement shall be made					
	no mechanical	after the	after the sample has been left in a normal temperature and					
	damage.	normal humidity for 1 hour.						
Change of	∆L/Lo≦±5%	The sam	The sample shall be subject to 5 continuos cycles, such as shown					
temperature		in the tal	in the table 2 below and then it shall be subjected to standard					
	There shall be	atmosph	atmospheric conditions for 1 hour, after which measurement					
	no other dama-	shall be made.						
	ge of problems							
			table 2					
				Temperature	Duration			
			1	−25±3 °C	30 min.			
				(Themostat No.1)				
			2	Standard	No.1→No.2 30 min.			
				atmospheric				
			3	85±2 ℃				
				(Themostat No.2)				
			4	Standard	No.2→No.1			
				atmospheric				
Moisture storage	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in a temperature of 40±2°C and a humidity(RH) of 90∼95%.						
	There shall be	Upon completion of the test, the measurement shall be made after the sample has been left in a normal temperature and normal humidity more than 1 hour.						
	no mechanical							
	damage.							
Test conditions:								
The s	ample shall be reflo	w soldered	onto	the printed circuit boar	d in every test.			

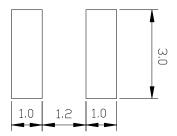


(5) LAND DIMENSION (Ref.)

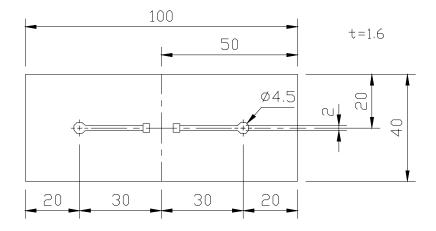
PCB: GLASS EPOXY t=1.6mm

(5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN) unit: mm

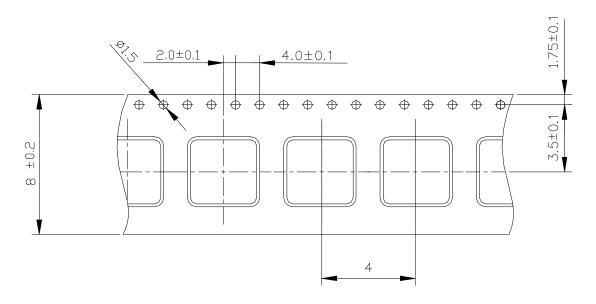


(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD



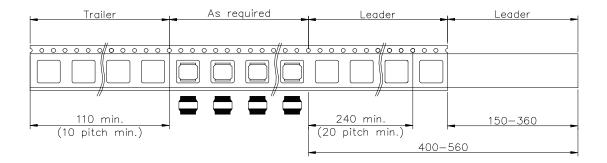
(6) PACKAGING

(6)-1 CARRIER TAPE DIMENSIONS (mm)

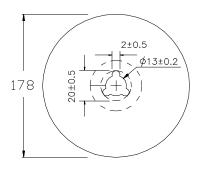


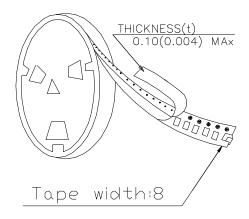
(6)-2 TAPING DIMENSIONS (mm)





(6)-3 REEL DIMENSIONS (mm)





(6)-4 QUANTITY

2500pcs/Reel

The products are packaged so that no damage will be sustained.